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**FPC Connector, 0.5mm Pitch, Connector SMT  
Type**

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**1. SCOPE**

**1.1. CONTENTS**

This specification covers the performance, tests and quality requirements for the FPC Connector, 0.5mm Pitch Connector SMT Type.

**1.2. QUALIFICATION**

When tests are performed on the subject product line, the procedures specified in Tyco 109 series specifications shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

**2. APPLICABLE DOCUMENT**

The following Tyco documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

**2.1. TYCO SPECIFICATIONS**

- A. 109-1 : General Requirements for the Test Specification
- B. 109-197 : Tyco Specification vs EIA and IEC Test Methods
- C. 501-57598 : Test Report

**3. REQUIREMENTS**

**3.1. DESIGN AND CONSTRUCTION**

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

**3.2. MATERIALS**

- A. Housing : Thermoplastic, UL94V-0
- B. Actuator : Thermoplastic, UL94 V-0
- C. Contact : Copper Alloy, Tin Plating or Gold Plating over Nickel under-plating.
- D. Hold Down : Copper Alloy, Tin Plating over Nickel under-plating.

**3.3. RATINGS**

- A. Voltage: 250 VAC
- B. Current: 0.5 A Max
- C. Temperature: - 20 °C to 85 °C

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**3.4. PERFORMANCE REQUIREMENT AND TEST DESCRIPTION**

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. All tests shall be performed at ambient environmental conditions per AMP Specification 109-1 TEST REQUIREMENTS AND PROCEDURES SUMMARY.

**3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY**

Test Item		Requirement	Procedure
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual inspection. No physical damage
<b>ELECTRICAL REQUIREMENT</b>			
2	Contact Resistance	35mΩ . Max.	Subject mated contacts assembled in housing to 20 mV DC Max open circuit at 100mA MIL-STD-1344A Method 3002.1
3	Insulation Resistance	100M Ohm Min.(Initial) 50M Ohm Min. ( Final)	Impressed voltage 500VDC. The insulation resistance shall be measured between 10 adjacent 10 opposing contacts per FPC connector. MIL-STD-202F, Method 302
4	Dielectric Withstanding Resistance	No creeping discharge or flashover shall occur. Current leakage:0.5mA MAX	250VAC for 1minute Test between adjacent circuits of unmated connector. MIL-STD-202F Method 301
<b>MECHANICAL REQUIREMENT</b>			
Test Item		Requirement	Procedure
5	Durability	See Note	Operation Speed: 25.4mm/minute Durability Cycles:15 Cycles
6	Vibration	No electrical discontinuity greater than 1microsecond shall occur. See Note.	(1)Test duration:3 hours along Each of 3 mutually perpendicular Plans(9hours totally) (2)Test board thickness:1.6±0.02mm MIL-STD-1344A,Method 2005
7	Physical Shock	During and after each shock, the contacts shall be no discontinuity greater then 1 microsecond.	(1)Number of drops:3 drops in each of 3 mutually perpendicular planes (2)Test board thickness:1.6±0.02mm MIL-STD-202F,Method 213.
8	Contact Retention Force	250 gf min.	The test shall be performed 10PCS of each different row of contacts the crosshead speed should be less than 20mm per minute.
9	Solder ability	Wet solder coverage:95% Min.	Solder Temp.:235±5°C Duration: 5±0.5sec. MIL-STD-202F,Method 208D.

Figure 1 ( cont )

MECHANICAL REQUIREMENT		
Test Item	Requirement	Procedure
10	Humidity	See Note
10	Humidity	See Note
11	Salt Spray	No detrimental corrosion allowed in contact area and base metal exposed.
11	Salt Spray	Subject mated connectors to 35±2°C and 5±1% salt(NaCl) for 48hrs. After test, rinse the sample with water and recondition the room temperature for 48hrs. MIL-STD-202F,Method 101D.1. condition B.
12	Thermal Shock	See Note
12	Thermal Shock	See Note
13	Temperature Life	See Note
13	Temperature Life	See Note
14	Resistance to Reflow Soldering Heat	No physical damage shall occur. (Lead-Free)
14	Resistance to Reflow Soldering Heat	Pre-soak condition, 85°C/85% RH for 168 hours. Pre Heat : 150~180°C, 90±30sec. Heat : 230°C Min., 30±10sec. Peak Temp. : 260+0/-5°C, 20~40sec. Duration : 3 cycles Tyco spec. 109-201, Condition B

Figure 1 ( End )

NOTE : Shall meet visual requirements, show no physical damage, and meet requirement of additional tests as specified in the test sequence in Figures 2

**3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST**

Test or Examination	Test Group								
	A	B	C	D	E	F	G	H	I
	Test Sequence (a)								
Examination of Product	1,9	1,9	1,9	1,7	1,3	1,6	1,3	1,3	1,5
Contact Resistance	2,6	2,6	2,6	2,6		2,5			2,4
Insulation Resistance	3,7	3,7	3,7	3,5					
Dielectric Withstanding Resistance	4,8	4,8	4,8	4					
Durability									
Vibration						3			
Physical Shock						4			
Contact Retention Force					2				
Solder ability							2		
Humidity	5								
Salt Spray		5							
Thermal Shock								2	
Temperature Life			5						
Resistance To Reflow Soldering Heat									3

Figure 2

NOTE : (a) Numbers indicate sequence in which tests are performed.

(b) Discontinuities shall not take place in this test group, during tests.